

MOSFET

600V CoolMOS™ SJ S7 Power Device

IPP60R065S7 enables the best price performance for low frequency switching applications. CoolMOS™ S7 boasts the lowest Rdson values for a HV SJ MOSFET, with distinctive increase of energy efficiency.

CoolMOS™ S7 is optimized for "static switching" and high current applications. It is an ideal fit for solid state relay and circuit breaker designs as well as for line rectification in SMPS and inverter topologies.

Features

- CoolMOS $^{\text{TM}}$ S7 technology enables $65m\Omega$ R_{DS(on)} in the smallest footprint
- Optimized price performance in low frequency switching applications
- · High pulse current capability
- TO220 package with total Pb-free die attach

Benefits

- Minimized conduction losses (eliminate / reduce heat sink)
- Increased system performance
- More compact and easier design
- Lower BOM or/and TCO over prolonged life time

Compared to electromechanical devices:

- Faster switching times
- · More reliability and longer system life time
- Shock & Vibration resistance
- · No contact arcing, bouncing or degradation over life time

Potential applications

- Solid state relays and circuit breakers
- Line rectification in high power/performance applications e.g. Computing, Telecom, UPS and Solar

Product validation

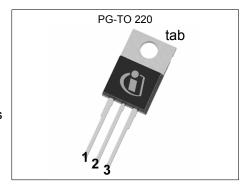
Fully qualified according to JEDEC for Industrial Applications

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



Parameter	Value	Unit
R _{DS(on),max}	65	mΩ
$Q_{g,typ}$	51	nC
V _{SD}	0.82	V
Pulsed I _{SD} , I _{DS}	126	A

Type / Ordering Code	Package	Marking	Related Links
IPP60R065S7	PG-TO220-3	60R065S7	see Appendix A



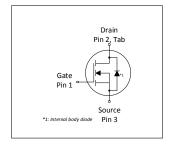












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1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum ratings**

Devementar	Cumb al	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain current rating	I _D	-	-	8	A	T_C =140°C Current is limited by $T_{j max}$ = 150°C; Lower case temp does increase current capability	
Pulsed drain current ¹⁾	I _{D,pulse}	-	-	126	Α	T _C =25°C	
Avalanche energy, single pulse	E _{AS}	-	-	97	mJ	I _D =2.3A; V _{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	2.3	Α	-	
MOSFET dv/dt ruggedness ²⁾	dv/dt	-	-	20	V/ns	V _{DS} = 0V to 300V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	167	W	T _C =25°C	
Storage temperature	T _{stg}	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Diode forward current rating	I _S	-	-	8	A	T_C =140°C Current is limited by $T_{j max}$ = 150°C; Lower case temp does increase current capability	
Diode pulse current ¹⁾	I _{S,pulse}	-	-	126	Α	T _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	5	V/ns	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ <=8A, $T_{\rm j}$ =25°C see table 8	
Maximum diode commutation speed	di _f /dt	-	-	820	A/μs	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ <=8A, $T_{\rm j}$ =25°C see table 8	
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, t=1min	

 $^{^{1)}}$ Pulse width t_p limited by $T_{j,\text{max}}$ $^{2)}$ The dv/dt has to be limited by appropriate gate resistor $^{3)}$ Identical low side and high side switch

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2 Thermal characteristics

Table 3 Thermal characteristics

Dava-mata-	Complete	Values			11	Nada / Tarad Orandidian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	0.75	°C/W	-	
Thermal resistance, junction - ambient		-	-	62	°C/W	leaded	
Thermal resistance, junction - ambient for SMD version	stance, junction - ambient R_{thJA}		-	-	°C/W	n.a.	
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s	

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Electrical characteristics

at T_i =25°C, unless otherwise specified

Table 4 Static characteristics

For applications with applied blocking voltage >70% of the specified blocking voltage, it is required that the customer evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon

Danamarkan	Ob. a.l	Values				N T O . !!!!	
Parameter	Symbol	Symbol Min. Typ. Max. Ur		Unit	Note / Test Condition		
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V_{GS} =0V, I_D =1mA	
Gate threshold voltage	$V_{(GS)th}$	3.5	4.0	4.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=0.49{\rm mA}$	
Zero gate voltage drain current	I _{DSS}	-	- 10	1 -	μА	V _{DS} =600V, V _{GS} =0V, T _j =25°C V _{DS} =600V, V _{GS} =0V, T _j =150°C	
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V	
Drain-source on-state resistance	R _{DS(on)}	-	0.059 0.138	0.065	Ω	V _{GS} =12V, I _D =8A, T _j =25°C V _{GS} =12V, I _D =8A, T _j =150°C	
Gate resistance	R _G	-	0.8	-	Ω	f=1MHz, open drain	

Table 5 **Dvnamic characteristics**

Davamatav	Combal		Values				
Parameter	Symbol	Min.	Тур. Мах.		Unit	Note / Test Condition	
Input capacitance	Ciss	-	1932	-	pF	V _{GS} =0V, V _{DS} =300V, f=250kHz	
Output capacitance	Coss	-	32	-	pF	V _{GS} =0V, V _{DS} =300V, f=250kHz	
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	104	-	pF V _{GS} =0V, V _{DS} =0 to 300V		
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	904	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0 to 300V	
Output charge	Qoss	-	271	-	nC	V _{GS} =0V, V _{DS} =0 to 300V	
Turn-on delay time	111M-00 0013V 11M0 1- 10S 1		$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =8A, $R_{\rm G}$ =10 Ω ; see table 9				
Rise time			$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =8A, $R_{\rm G}$ =10Ω; see table 9				
Turn-off delay time	$t_{\rm d(off)}$ - 96 - ns $V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =8A, $R_{\rm G}$ =10 Ω ; see table 9						
Fall time	t _f	-	11	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =8A, $R_{\rm G}$ =10 Ω ; see table 9	

Table 6 Gate charge characteristics

Parameter	Cumbal	Values			11:4	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	11	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =8A, $V_{\rm GS}$ =0 to 12V
Gate to drain charge	Q _{gd}	-	17	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =8A, $V_{\rm GS}$ =0 to 12V
Gate charge total	Qg	-	51	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =8A, $V_{\rm GS}$ =0 to 12V
Gate plateau voltage	V _{plateau}	-	5.4	-	V	V_{DD} =300V, I_{D} =8A, V_{GS} =0 to 12V

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 300V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 300V

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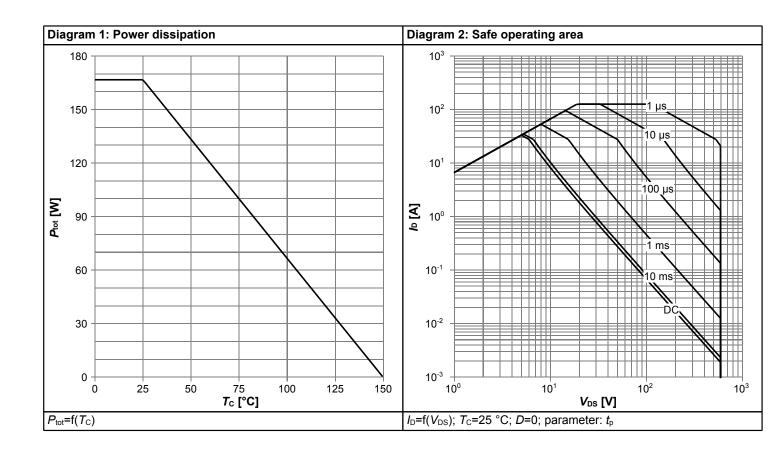


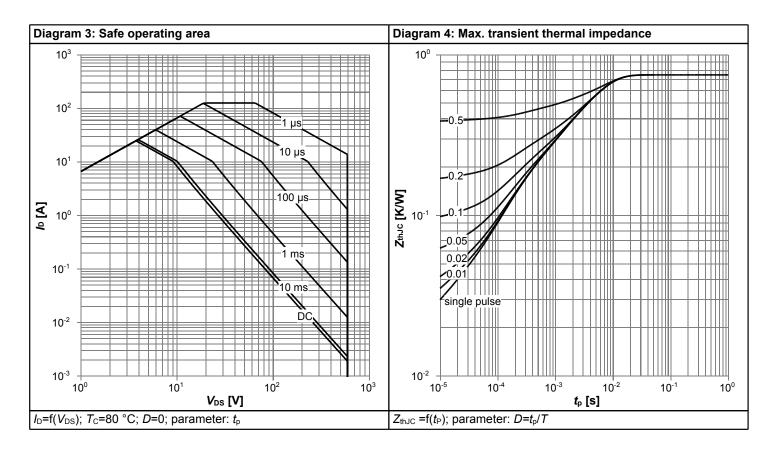
Table 7 Reverse diode characteristics

Doromotor	Cumbal		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode forward voltage	V _{SD}	-	0.82	-	V	V_{GS} =0V, I_{F} =8A, T_{j} =25°C	
Reverse recovery time	t _{rr}	-	310	-	ns	V_R =300V, I_F =8A, di_F/dt =100A/ μ s; see table 8	
Reverse recovery charge	Q _{rr}	-	3.9	-	μC	V_R =300V, I_F =8A, di_F/dt =100A/ μ s; see table 8	
Peak reverse recovery current	I _{rrm}	-	27	-	Α	V_R =300V, I_F =8A, di_F/dt =100A/ μ s; see table 8	

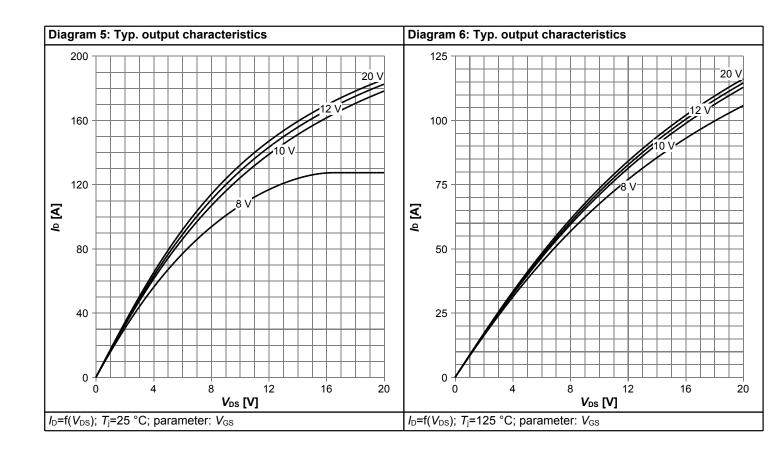


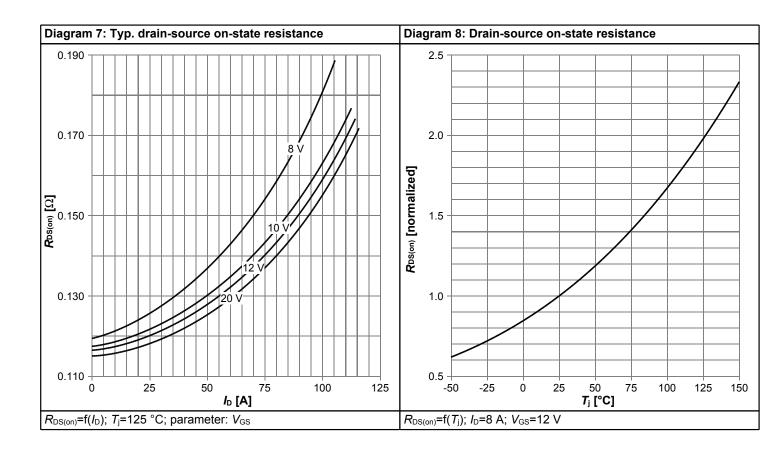
4 Electrical characteristics diagrams



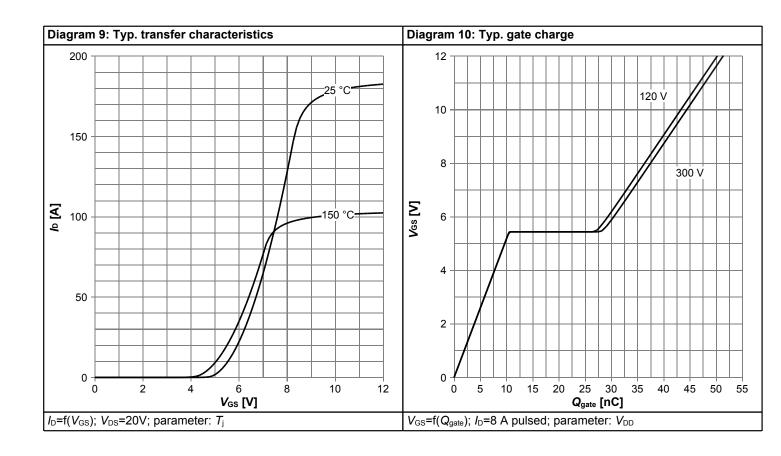


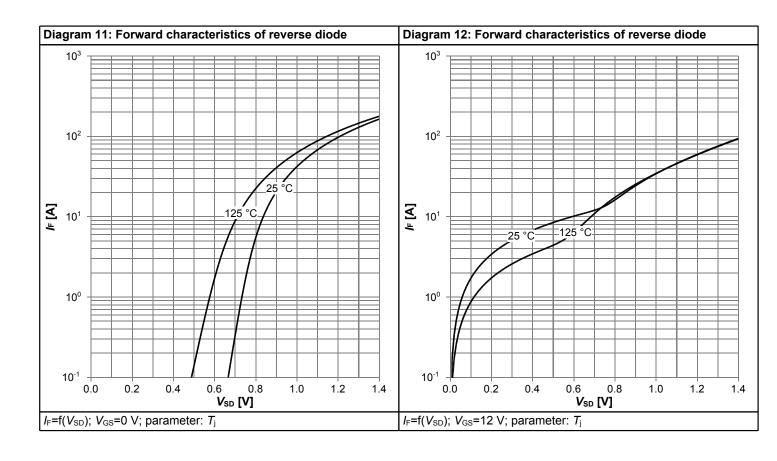




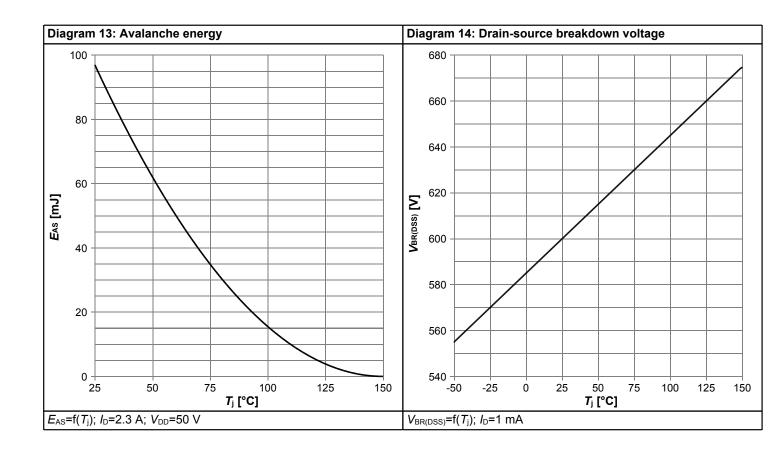


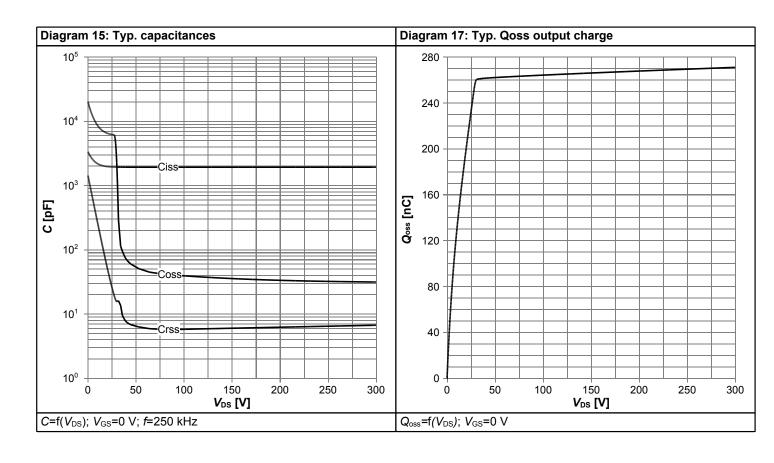














5 Test Circuits

Table 8 Diode characteristics

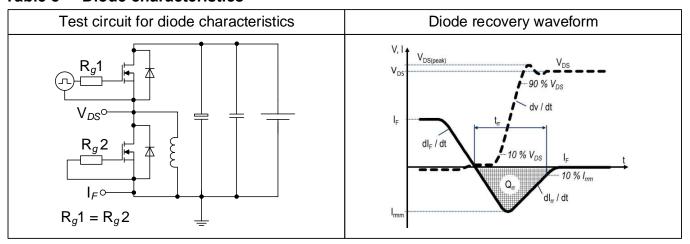


Table 9 Switching times

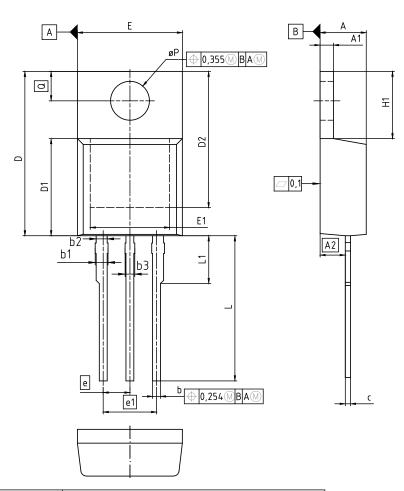


Table 10 Unclamped inductive load





6 Package Outlines



DIM	MILLI	METERS	INCH	IES	
DIM	MIN	MAX	MIN	MAX	
Α	4.30	4.57	0.169	0.180	
A1	1.17	1.40	0.046	0.055	
A2	2.15	2.72	0.085	0.107	
b	0.65	0.86	0.026	0.034	
b1	0.95	1.40	0.037	0.055	
b2	0.95	1.15	0.037	0.045	
b3	0.65	1.15	0.026	0.045	
С	0.33	0.60	0.013	0.024	
D	14.81	15.95	0.583	0.628	
D1	8.51	9.45	0.335	0.372	
D2	12.19	13.10	0.480	0.516	
E	9.70	10.36	0.382	0.408	
E1	6.50	8.60	0.256	0.339	
е	2	.54	0.100		
e1	5	.08	0.200		
N		3	3	3	
H1	5.90	6.90	0.232	0.272	
L	13.00	14.00	0.512	0.551	
L1	-	4.80	-	0.189	
øΡ	3.60	3.89	0.142	0.153	
Q	2.60	3.00	0.102	0.118	

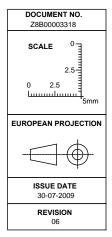


Figure 1 Outline PG-TO220-3, dimensions in mm/inches

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7 Appendix A

Table 11 Related Links

• IFX CoolMOS S7 Webpage: www.infineon.com

• IFX CoolMOS S7 application note: www.infineon.com

• IFX CoolMOS S7 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

IPP60R065S7



Revision History

IPP60R065S7

Revision: 2021-08-20, Rev. 2.1

Previous Revision

1 10110401	Troviduo Neviolett							
Revision	n Date Subjects (major changes since last revision)							
2.0	2021-08-10	Release of final version						
2.1	2021-08-20	Change of wording regarding breakdown voltage / cosmic ray						

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